

# PAL10/10016P4A 4 ns ECL Programmable Array Logic

#### **General Description**

The PAL1016P4A and PAL10016P4A are members of the National Semiconductor ECL PAL® family. The PAL10/10016P4A is a functional subset of the PAL10/10016P8 (6 ns tpd) and is compatible in pinout, JEDEC map format, and programming algorithm. The ECL PAL family utilizes National Semiconductor's advanced oxide-isolated process and proven Titanium-Tungsten (Ti-W) fuse technology to provide user-programmable logic to replace conventional ECL SSI/MSI gates and flip-flops. Typical chip count reduction gained by using PAL devices is greater than 4:1.

This family allows the systems engineer to customize his chip by opening fuse links to configure AND and OR gates to perform his desired logic function. Complex interconnections that previously required time-consuming layout are thus transferred from PC board to silicon where they can easily be modified during prototype checkout or production.

The PAL transfer function is the familiar sum-of-products implemented with a single array of fusible links. The PAL device incorporates a programmable AND array driving a fixed OR array. The AND term logic matrix incorporates 16 complementary inputs and 32 product terms. The 32 product terms are grouped into four OR functions with eight product terms each. All devices in this series are provided with output polarity fuses. These fuses permit the designer to configure each output independently to provide either a logic true (by leaving the fuse intact) or a logic false (by programming the fuse) when the equation defining that output is satisfied.

Product terms with all fuses programmed assume a logical high state, while product terms connected to both the true

and complement of any input assume a logical low state. All product terms in an unprogrammed part are logically low. Fuse symbols have been omitted from the logic diagrams to allow the designer use of the diagrams for logic editing.

These ECL PAL devices may be programmed on many PLD programmers. Programming is accomplished using TTL voltage levels. Once programmed and verified, an additional fuse may be programmed to disable further verification. This feature gives the user a proprietary circuit which is difficult to copy.

#### **Features**

- High speed: Combinatorial outputs tpd = 4 ns max
- Both 10 KH and 100K I/O compatible versions
- Four output functions; sixteen dedicated inputs
- Individually programmable polarity for all logic outputs
- Reliable titanium-tungsten fuses
- Security fuse to prevent direct copying
- Programmed on many PLD programmers
- Fully Supported by PLAN™ Software
- Packaging:

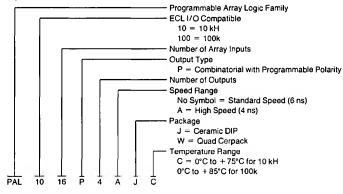
24-pin thin DIP (0.300") 24-pin QUAD CERPAK

#### **Applications**

- Programmable replacement for ECL logic
- Address or instruction decoding

## **Ordering Information**

The device number is used to form part of a simplified purchasing code where a package type and temperature range are defined as follows:



#### **Absolute Maximum Ratings**

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Temperature Under Bias

-55°C to +125°C

Storage Temperature Range VEE Relative to VCC

-65°C to +150°C

Any Input Relative to V<sub>CC</sub>

-7V to +0.5V $V_{EE} \text{ to } +0.5V$  Lead Temperature (Soldering, 10 seconds)

300°C

1000V

**ESD Tolerance** 

 $C_{ZAP} = 100 \text{ pF}$  $R_{ZAP} = 1500\Omega$ 

Test Method: Human Body Model

Test Specification: NSC SOP-5-028

#### **Recommended Operating Conditions**

Symbol	Parameter		Min	Тур	Max	Units
VEE	Supply Voltage	10 KH	-5.46	-5.2	-4.94	v
		100K	-4.73	-4.5	-4.27	•
Т	Operating Temperature (Note)	10 KH	0		+ 75	°C
		100K	0		+85	

## DC Electrical Characteristics Over Recommended Operating Conditions

Output Load =  $50\Omega$  to -2.0V

Symbol	Parameter	Conditions		TA	Min	Max	Units
V <sub>IH</sub>	High Level Input Voltage	Guaranteed Input Voltage High For All Inputs	10 KH	0°C + 25°C + 75°C	-1170 -1130 -1070	-840 -810 -735	mV
			100K	0°C to +85°C	-1165	-880	
V <sub>IL</sub>	Low Level Input Voltage	Guaranteed Input Voltage Low For All Inputs	10 KH	0°C + 25°C + 75°C	-1950 -1950 -1950	-1480 -1480 -1450	mV
			100K	0°C to +85°C	-1810	- 1475	
V <sub>OH</sub>	High Level Output Voltage	$V_{IN} = V_{IH}$ Max. or $V_{IL}$ Min.	10 KH	0°C + 25°C + 75°C	-1020 -980 -920	-840 -810 -735	mV
			100K	0°C to +85°C	- 1025	-880	
V <sub>OL</sub>	Low Level Output Voltage	$V_{IN} = V_{IH}$ Max. or $V_{IL}$ Min.	10 KH	0°C + 25°C + 75°C	-1950 -1950 -1950	-1630 -1630 -1600	mV
		_	100K	0°C to +85°C	-1810	-1620	
Ін	High Level Input Current	V <sub>IN</sub> = V <sub>IH</sub> Max.	10 KH	0°C +75°C		220	μΑ
			100K	0°C to +85°C			
I <sub>IL</sub>	Low Level Input Current	V <sub>IN</sub> = V <sub>IL</sub> Min.	10 KH	0°C + 75°C	0.5		μА
			100K	0°C to +85°C			
IEE	Supply Current	V <sub>EE</sub> = Min.	10 KH	0°C to +75°C	-220		mA
		All Inputs and Outputs Open	100K	0°C to +85°C			""

Note: Operating temperatures for circuits in Dual-In-Line packages are specified as ambient temperatures (T<sub>A</sub>) with circuits in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Operating temperatures for circuits packaged in QUAD CERPAK are specified as case temperatures (T<sub>C</sub>). All specifications apply after thermal equilibrium has been established.

Switching Characteristics Over Recommended Operating Conditions, Output load:  $R_L=50\Omega$  to  $-2.0\text{V},\,C_L=5\,\text{pF}$  to GND

Symbol	Parameter	Measured Test Conditions	Min	Max	Units
t <sub>PD</sub>	Input to Output	Measured at threshold points (Note 1)		4	ns
t <sub>r</sub>	Output Rise Time	Measured between	0.5	2.5	ns
tı	Output Fall Time	20% and 80% points	0.5	2.5	ns

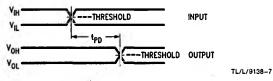
Note 1: All AC measurements are to be made from threshold point.

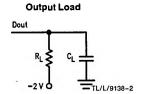
VIH = Threshold + 400 mV

VIL = Threshold - 400 mV

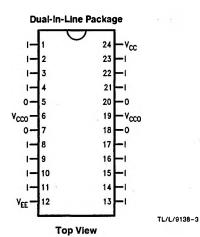
Part	Temp	VIHMIN	V <sub>ILMax</sub>	Threshold	V <sub>IH</sub>	VIL
10 kH	-55°C	-1250	- 1480	-1365	-965	- 1765
10 kH	ଙ୍	-1170	-1480	- 1325	-925	-1725
10 kH	25°C	-1130	-1480	-1300	-900	-1700
10 kH	75°C	-1070	~1450	-1260	-860	-1660
10 kH	125°C	-1000	- 1420	-1210	-810	- 1610
100 k	All	-1165	-1475	-1300	-900	-1700

## **Timing Measurements**

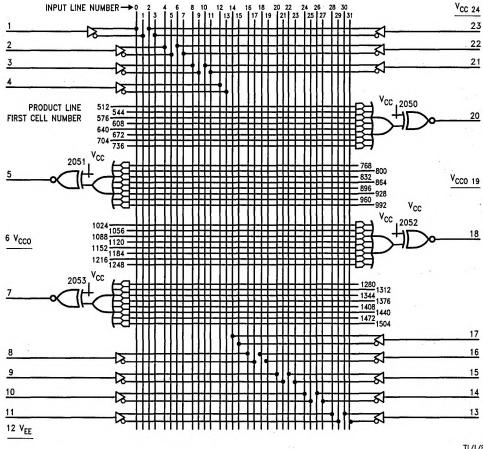




## **Connection Diagram**



#### Logic Diagram PAL1016P4A/PAL10016P4A



TL/L/9138-4

JEDEC logic array cell number = product line first cell number + input line number

#### **Functional Testing**

As with all field-programmable devices, the user of the ECL PAL devices provides the final manufacturing step. While National's PAL devices undergo extensive testing when they are manufactured, their logic function can be fully tested only after they have been programmed to the user's pattern.

To ensure that the programmed PAL devices will operate properly in your system, National Semiconductor (along with most other manufacturers of PAL devices) strongly recom-

mends that devices be functionally tested before being installed in your system. Even though the number of post-programming functional failures is small, testing the logic function of the PAL devices before they reach system assembly will save board debugging and rework costs. Refer to National Semiconductor's Application Note #351 and the Programmable Logic Design Guide for more information about the functional testing of PAL devices.

Please contact your local sales office for a list of current programming support tools for ECL PAL devices.